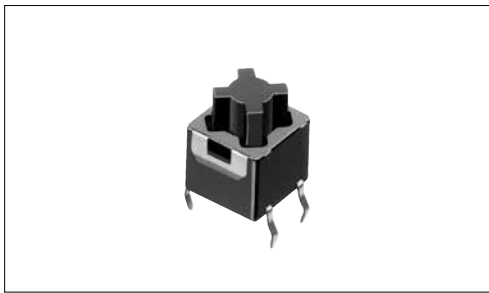


Combination of long travel 1.75mm and high operation force prevents malfunction



Typical Specifications



Items	Specifications
Rating (max.)	5mA 12V DC
Rating (min.)	10 μ A 1V DC
Initial contact resistance	1k Ω max.
Travel (mm)	1.75

Product Line

Product No.	Operating force	Operating direction	Operating life (5mA 5V DC)	Minimum order unit (pcs.)	
				Japan	Export
SKPFACA010	1.96N	Top push	100,000 cycles	1,000	1,000
SKPFAAA010	3.92N				

Packing Specifications

Bulk

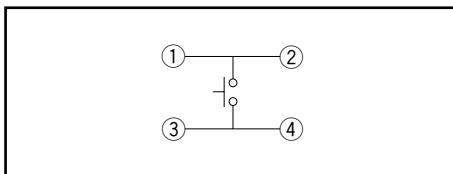
Number of packages (pcs.)		Export package measurements (mm)
1 case / Japan	1 case / export packing	
4,000	12,000	309×476×347

Dimensions

Unit:mm

Style	PC board mounting hole dimensions (Viewed from switch mounting face)

















Circuit Diagram



Note

Please Using a 1.6mm thick PC board is recommended.

Refer to P.249 for soldering conditions.

Type		Sharp Feeling Type			Soft Feeling Type				
		Surface Mount			Snap-in	Surface Mount			
Series		SKSC	SKRT	SKRH	SKPF	SKPS	SKPM	SKPG	SKPR
Photo									
Features		Low-profile	—	4-direction switch +push switch	High operation force Long travel	Low contact resistance		—	High operation force Low contact resistance
Water-proof		—	—	—	—	—	—	—	—
Dust-proof		—	—	—	—	—	—	—	—
IP standard		—	—	—	—	—	—	—	—
Operating direction	Top push	—	—	●	●	●	●	●	●
	Side push	●	●	●	—	—	—	—	—
Dimensions (mm)	W	3.5	4.5	7.35	8	5.9		6.6	7.5
	D	3.55	3.4	7.5	9	6		6.3	7.8
	H	1.25	3.3	5	10	5			6.5
Contact		—	—	—	Carbon	Silver		Carbon	Silver
Operation force coverage	1N max.			See the relevant pages for respective product descriptions					
	1N to 2N	↕	↕		↕		↕	↕	↕
	2N to 3N								
	3N to 4N								
4N to 5N				↕					
Travel (mm)		0.2		1.75	See the relevant pages for respective product descriptions	1.05	1.3		1
Ground terminal		○	●	●	—	—	—	—	—
Operating temperature range		−30℃ to +85℃	−40℃ to +90℃	−40℃ to +85℃	−40℃ to +90℃				
Automotive use		—	—	—	●	●	●	●	●
Life Cycle									
Electrical performance	Rating (max.) (Resistive load)	50mA 12V DC				50mA 16V DC		5mA 12V DC	50mA 16V DC
	Rating (min.) (Resistive load)	10μA 1V DC							
	Insulation resistance	100MΩ min. 100V DC 1min.							
	Voltage proof	100V AC 1min.	250V AC 1min.	100V AC 1min.	250V AC 1min.				
Durability	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively							
	Lifetime	Shall be in accordance with individual specifications.							
Environmental performance	Cold	−40℃ 96h				−40℃ 1,000h		−40℃ 96h	−40℃ 1,000h
	Dry heat	90℃ 96h				90℃ 1,000h		90℃ 96h	90℃ 1,000h
	Damp heat	60℃, 90 to 95%RH 96h				60℃, 90 to 95%RH 1,000h		60℃, 90 to 95%RH 96h	60℃, 90 to 95%RH 1,000h
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W : Width. The most outer dimension excluding terminal portion.

D : Depth. The most outer dimension excluding terminal portion.

H : Height. The minimum dimension if there are variances.

TACT Switch™ Soldering Conditions 249

TACT Switch™ Cautions 250

Notes

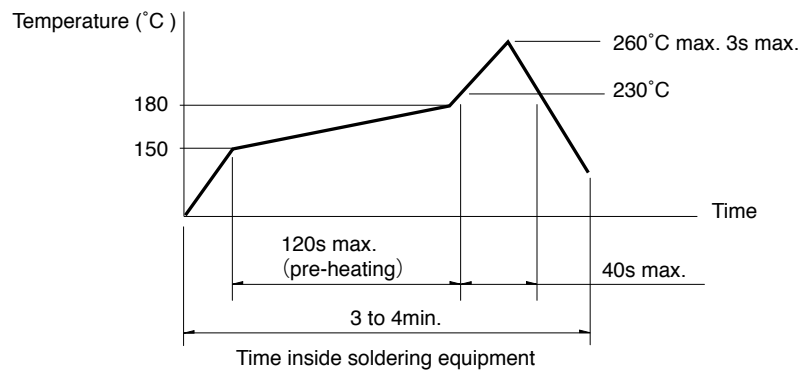
1. The automotive operating temperature range to be individually discussed upon request.

2. ● Indicates applicability to all products in the series.

■ Condition for Reflow

Available for Surface Mount Type.

Temperature profile



Notes

1. Please confirm the specifications of our product for the detailed condition.
2. Soldering conditions differ depending on reflow soldering machines.
Prior verification of soldering condition is highly recommended.

■ Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHLTop Push Type, SKQJ Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

Notes

1. Prevent flux penetration from the top side of the TACT Switch™.
2. Switch terminals and a PC board should not be coated with flux prior to soldering.
3. The second soldering should be done after the switch is stable with normal temperature.
4. Use the flux with a specific gravity of min 0.81.
(EC-19S-8 by TAMURA CORPORATION, or equivalents.)

■ Manual Soldering

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH, SKHW Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Mouser Electronics

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ALPS:

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